

# LOCTITE ABLESTIK QMI516

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## PRODUCT DESCRIPTION

LOCTITE ABLESTIK QMI516 provides the following product characteristics:

<b>Technology</b>	Silver Filled
<b>Appearance</b>	Silver
<b>Components</b>	One component - requires no mixing
<b>Cure</b>	Heat cure
<b>Application</b>	Die attach

LOCTITE ABLESTIK QMI516 is a silver filled conductive adhesive for attachment of integrated circuits and components to metal leadframes advanced substrates, including: SBGA's, PBGA's, array packages, tape packs and CSP's. This material is hydrophobic and stable at high temperatures. These features produce void-free bonds lines with excellent interfacial adhesion strength to a wide variety of organic and metal surfaces, including solder mask, BT, FR, polyimide, Au, Kapton™ and Mylar™. A package or device manufactured with LOCTITE ABLESTIK QMI516 will have good resistance to delamination and "popcorning" after exposure to reflow temperatures. The adhesive also has excellent electrical and thermal conductivity properties. LOCTITE ABLESTIK QMI516 can be cured in a conventional oven, on a snap cure oven, or utilize SkipCure™ processing on a die bonder or wire bonder. The material is formulated to produce cure onset below 100°C. This can reduce or eliminate the need to pre-dry organic substrates prior to the die attach process.

## TYPICAL PROPERTIES OF UNCURED MATERIAL

Specific Gravity @ 25 °C	3.93
Viscosity @ 25 °C, cPs:	
Speed 5 rpm	8,000
Thixotropic Index (Speed 0.5/speed 5)	3.0
Pot Life @ 25 °C, hours	24

## TYPICAL PROPERTIES OF CURED MATERIAL

### Physical Properties

Glass Transition Temperature (Tg), °C	33
Coefficient of Thermal Expansion, TMA:	
Alpha 1, ppm/°C	51
Alpha 2, ppm/°C	112
Thermal Conductivity, W/(m-K)	4.2
DMA Modulus @ 25°C	N/mm <sup>2</sup> 1.8 (psi) (261,000)

### Extractable Ionic Content, :

Sodium (Na+)	≤20
Potassium (K+)	≤20
Chloride (Cl-)	≤20
Fluoride (F-)	≤20

Moisture Absorption, 168 hours @ 85°C/85% RH, ≤0.2 wt. %

### Electrical Properties

Volume Resistivity, Ω·cm	≥0.0017
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## TYPICAL PERFORMANCE OF CURED MATERIAL

### Miscellaneous

Die Shear Strength :	
(300 mil <sup>2</sup> , 1 mil BLT) Average kg-f @ 25°C	≥17

## GENERAL INFORMATION

**For safe handling information on this product, consult the Material Safety Data Sheet, (MSDS).**

### Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

### Cure Schedule

SkipCure	≥8 seconds @ 150 °C
Conventional Oven	15 minutes @ 150 °C
Snap Cure Oven	≥10 seconds @ 150 °C
Tunnel Oven:	≥10 seconds @ 150 °C
configured with hot gas or IR	

LOCTITE ABLESTIK QMI516 can be cured using a variety of times and temperatures, depending upon the specific cure equipment. Typical cure profiles are listed below. In these profiles, the temperatures stated are bondline temperatures and the stated times are at temperature.

### Storage

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

**Optimal Storage: -40 °C. Storage below minus (-)40 °C or greater than minus (-)40 °C can adversely affect product properties.**

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

**Conversions** $(^{\circ}\text{C} \times 1.8) + 32 = ^{\circ}\text{F}$  $\text{kV/mm} \times 25.4 = \text{V/mil}$  $\text{mm} / 25.4 = \text{inches}$  $\text{N} \times 0.225 = \text{lb}$  $\text{N/mm} \times 5.71 = \text{lb/in}$  $\text{N/mm}^2 \times 145 = \text{psi}$  $\text{MPa} = \text{N/mm}^2$  $\text{MPa} \times 145 = \text{psi}$  $\text{N}\cdot\text{m} \times 8.851 = \text{lb}\cdot\text{in}$  $\text{N}\cdot\text{m} \times 0.738 = \text{lb}\cdot\text{ft}$  $\text{N}\cdot\text{mm} \times 0.142 = \text{oz}\cdot\text{in}$  $\text{mPa}\cdot\text{s} = \text{cP}$ **Disclaimer****Note**

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Reference 0.1